

DATA SHEET

74LVT16374A

**3.3V LVT 16-bit edge-triggered D-type
flip-flop (3-State)**

Product specification
Supersedes data of 1998 Feb 19
IC23 Data Handbook

1999 Oct 18

3.3V 16-bit edge-triggered D-type flip-flop (3-State)

74LVT16374A

FEATURES

- 16-bit edge-triggered flip-flop
- 3-State buffers
- Output capability: +64mA/-32mA
- TTL input and output switching levels
- Input and output interface capability to systems at 5V supply
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion/extraction permitted
- Power-up reset
- Power-up 3-State
- No bus current loading when output is tied to 5V bus
- Latch-up protection exceeds 500mA per JEDEC Std 17
- ESD protection exceeds 2000V per MIL STD 883 Method 3015 and 200V per Machine Model

DESCRIPTION

The 74LVT16374A is a high-performance BiCMOS product designed for V_{CC} operation at 3.3V.

This device is a 16-bit edge-triggered D-type flip-flop featuring non-inverting 3-State outputs. The device can be used as two 8-bit flip-flops or one 16-bit flip-flop. On the positive transition of the clock (CP), the Q outputs of the flip-flop take on the logic levels set up at the D inputs.

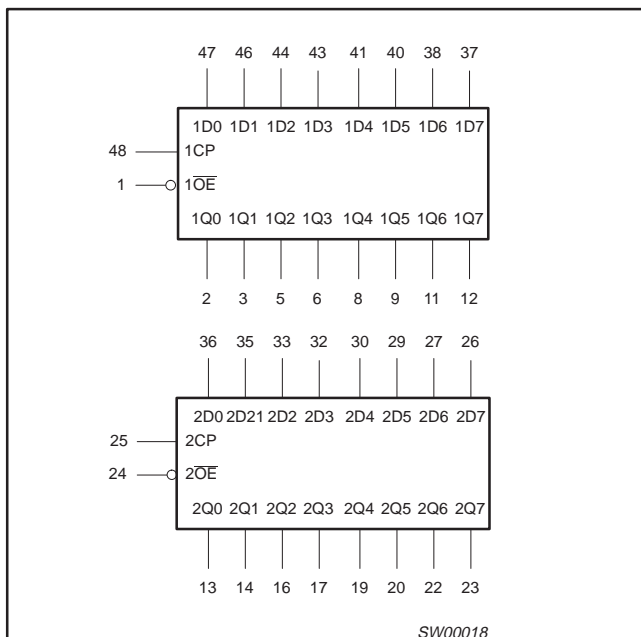
QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS $T_{amb} = 25^{\circ}C$ | TYPICAL | UNIT |
|------------------------|---------------------------------|--|---------|---------|
| t_{PLH} t_{PHL} | Propagation delay nCP to nQx | $C_L = 50pF$; $V_{CC} = 3.3V$ | 2.9 | ns |
| C_{IN} | Input capacitance | $V_I = 0V$ or $3.0V$ | 3 | pF |
| C_{OUT} | Output pin capacitance | Outputs disabled; $V_O = 0V$ or $3.0V$ | 9 | pF |
| I_{CCZ} | Total supply current | Outputs disabled; $V_{CC} = 3.6V$ | 70 | μA |

ORDERING INFORMATION

| PACKAGES | TEMPERATURE RANGE | OUTSIDE NORTH AMERICA | NORTH AMERICA | DWG NUMBER |
|------------------------------|-------------------|-----------------------|---------------|------------|
| 48-Pin Plastic SSOP Type III | -40°C to +85°C | 74LVT16374A DL | VT16374A DL | SOT370-1 |
| 48-Pin Plastic TSSOP Type II | -40°C to +85°C | 74LVT16374A DGG | VT16374A DGG | SOT362-1 |

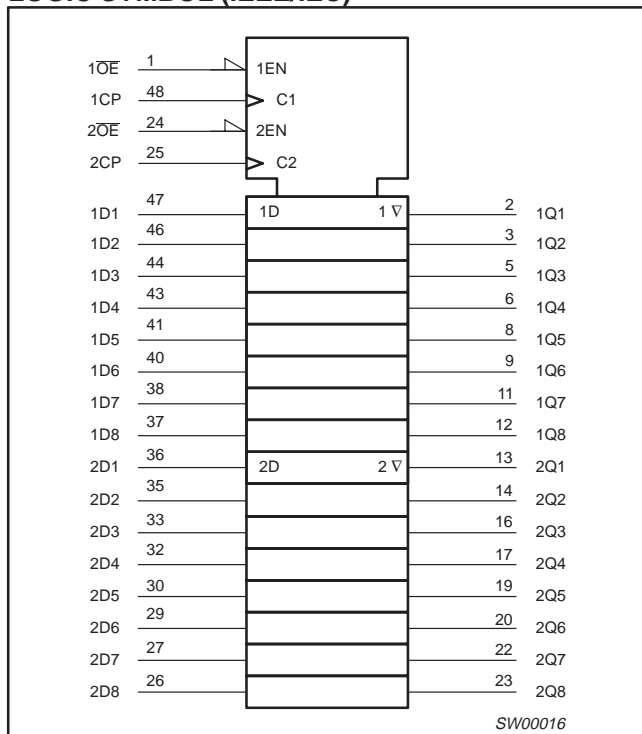
LOGIC SYMBOL



3.3V 16-bit edge-triggered D-type flip-flop (3-State)

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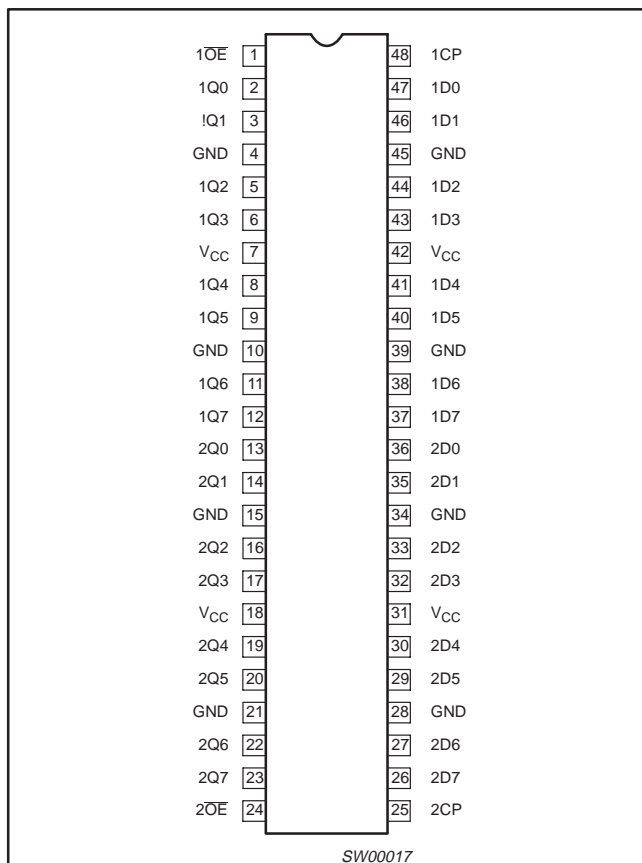
LOGIC SYMBOL (IEEE/IEC)



PIN DESCRIPTION

| PIN NUMBER | SYMBOL | FUNCTION |
|--|------------------------|---|
| 47, 46, 44, 43, 41, 40, 38, 37, 36, 35, 33, 32, 30, 29, 27, 26 | 1D0 - 1D7 2D0 - 2D7 | Data inputs |
| 2, 3, 5, 6, 8, 9, 11, 12, 13, 14, 16, 17, 19, 20, 22, 23 | 1Q0 - 1Q7 2Q0 - 2Q7 | Data outputs |
| 1, 24 | 1OE, 2OE | Output enable inputs (active-Low) |
| 48, 25 | 1CP, 2CP | Clock pulse inputs (active rising edge) |
| 4, 10, 15, 21, 28, 34, 39, 45 | GND | Ground (0V) |
| 7, 18, 31, 42 | V _{CC} | Positive supply voltage |

PIN CONFIGURATION



3.3V 16-bit edge-triggered D-type flip-flop (3-State)

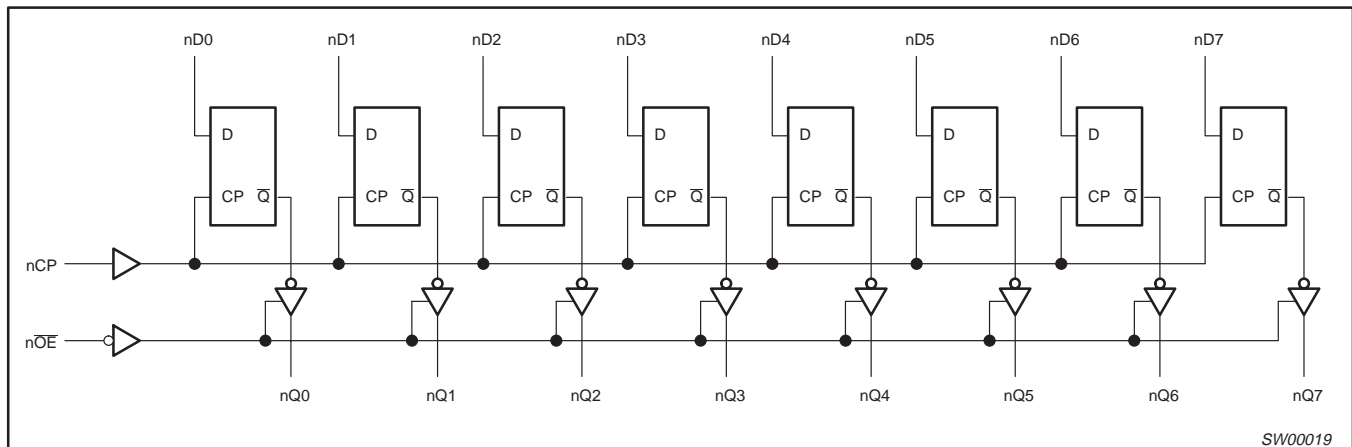
74LVT16374A

FUNCTION TABLE

| INPUTS | | | INTERNAL REGISTER | OUTPUTS | OPERATING MODE |
|--------|--------|----------|-------------------|-----------|------------------------|
| nOE | nCP | nDx | | nQ0 - nQ7 | |
| L L | ↑ ↑ | l h | L H | L H | Load and read register |
| L | ↑ | X | NC | NC | Hold |
| H H | ↑ ↑ | X nDx | NC nDx | Z Z | Disable outputs |

H = High voltage level
 h = High voltage level one set-up time prior to the High-to-Low E transition
 L = Low voltage level
 l = Low voltage level one set-up time prior to the High-to-Low E transition
 NC= No change
 X = Don't care
 Z = High impedance "off" state
 ↑ = Low-to-High clock transition
 ↑ = Not a Low-to-High clock transition

LOGIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS^{1, 2}

| SYMBOL | PARAMETER | CONDITIONS | RATING | UNIT |
|------------------|--------------------------------|-----------------------------|--------------|------|
| V _{CC} | DC supply voltage | | -0.5 to +4.6 | V |
| I _{IK} | DC input diode current | V _I < 0 | -50 | mA |
| V _I | DC input voltage ³ | | -0.5 to +7.0 | V |
| I _{OK} | DC output diode current | V _O < 0 | -50 | mA |
| V _{OUT} | DC output voltage ³ | Output in Off or High state | -0.5 to +7.0 | V |
| I _{OUT} | DC output current | Output in Low state | 128 | mA |
| | | Output in High state | -64 | |
| T _{stg} | Storage temperature range | | -65 to +150 | °C |

NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
- The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

3.3V 16-bit edge-triggered D-type flip-flop (3-State)

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RECOMMENDED OPERATING CONDITIONS

| SYMBOL | PARAMETER | LIMITS | | UNIT |
|------------------|--|--------|-----|------|
| | | MIN | MAX | |
| V _{CC} | DC supply voltage | 2.7 | 3.6 | V |
| V _I | Input voltage | 0 | 5.5 | V |
| V _{IH} | High-level input voltage | 2.0 | | V |
| V _{IL} | Input voltage | | 0.8 | V |
| I _{OH} | High-level output current | | -32 | mA |
| I _{OL} | Low-level output current | | 32 | mA |
| | Low-level output current; current duty cycle ≤ 50%; f ≥ 1kHz | | 64 | |
| Δt/Δv | Input transition rise or fall rate; Outputs enabled | | 10 | ns/V |
| T _{amb} | Operating free-air temperature range | -40 | +85 | °C |

DC ELECTRICAL CHARACTERISTICS

| SYMBOL | PARAMETER | TEST CONDITIONS | LIMITS | | | UNIT |
|--------------------|--|---|------------------------|------------------|------|------|
| | | | Temp = -40°C to +85°C | | | |
| | | | MIN | TYP ¹ | MAX | |
| V _{IK} | Input clamp voltage | V _{CC} = 2.7V; I _{IK} = -18mA | | -85 | -1.2 | V |
| V _{OH} | High-level output voltage | V _{CC} = 2.7 to 3.6V; I _{OH} = -100μA | V _{CC} -0.2 | V _{CC} | | V |
| | | V _{CC} = 2.7V; I _{OH} = -8mA | 2.4 | 2.5 | | |
| | | V _{CC} = 3.0V; I _{OH} = -32mA | 2.0 | 2.3 | | |
| V _{OL} | Low-level output voltage | V _{CC} = 2.7V; I _{OL} = 100μA | | 0.07 | 0.2 | V |
| | | V _{CC} = 2.7V; I _{OL} = 24mA | | 0.3 | 0.5 | |
| | | V _{CC} = 3.0V; I _{OL} = 16mA | | 0.25 | 0.4 | |
| | | V _{CC} = 3.0V; I _{OL} = 32mA | | 0.3 | 0.5 | |
| | | V _{CC} = 3.0V; I _{OL} = 64mA | | 0.4 | 0.55 | |
| V _{RST} | Power-up output Low voltage ⁵ | V _{CC} = 3.6V; I _O = 1mA; V _I = GND or V _{CC} | | 0.1 | 0.55 | V |
| I _I | Input leakage current | V _{CC} = 3.6V; V _I = V _{CC} or GND | Control pins | 0.1 | ±1 | μA |
| | | V _{CC} = 0 or 3.6V; V _I = 5.5V | | 0.4 | 10 | |
| | | V _{CC} = 3.6V; V _I = V _{CC} | Data pins ⁴ | 0.1 | 1 | |
| | | V _{CC} = 3.6V; V _I = 0 | | -0.4 | -5 | |
| I _{OFF} | Output off current | V _{CC} = 0V; V _I or V _O = 0 to 4.5V | | 0.1 | ±100 | μA |
| I _{HOLD} | Bus Hold current D inputs ⁷ | V _{CC} = 3V; V _I = 0.8V | | 75 | 135 | μA |
| | | V _{CC} = 3V; V _I = 2.0V | | -75 | -135 | |
| | | V _{CC} = 0V to 3.6V; V _{CC} = 3.6V | | ±500 | | |
| I _{EX} | Current into an output in the High state when V _O > V _{CC} | V _O = 5.5V; V _{CC} = 3.0V | | 50 | 125 | μA |
| I _{PU/PD} | Power up/down 3-State output current ³ | V _{CC} ≤ 1.2V; V _O = 0.5V to V _{CC} ; V _I = GND or V _{CC} ; OE/OE = Don't care | | 1 | ±100 | μA |
| I _{OZH} | 3-State output High current | V _{CC} = 3.6V; V _O = 3.0V; V _I = V _{IH} or V _{IL} | | 0.5 | 5 | μA |
| I _{OZL} | 3-State output Low current | V _{CC} = 3.6V; V _O = 0.5V; V _I = V _{IH} or V _{IL} | | 0.5 | -5 | |
| I _{CCH} | Quiescent supply current | V _{CC} = 3.6V; Outputs High, V _I = GND or V _{CC} , I _O = 0 | | 0.07 | 0.12 | mA |
| I _{CCL} | | V _{CC} = 3.6V; Outputs Low, V _I = GND or V _{CC} , I _O = 0 | | 4 | 6 | |
| I _{CCZ} | | V _{CC} = 3.6V; Outputs Disabled; V _I = GND or V _{CC} , I _O = 0 ⁶ | | 0.07 | 0.12 | |
| ΔI _{CC} | Additional supply current per input pin ² | V _{CC} = 3V to 3.6V; One input at V _{CC} -0.6V, Other inputs at V _{CC} or GND | | 0.1 | 0.2 | mA |

NOTES:

- All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.
- This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND
- This parameter is valid for any V_{CC} between 0V and 1.2V with a transition time of up to 10msec. From V_{CC} = 1.2V to V_{CC} = 3.3V ± 0.3V a transition time of 100μsec is permitted. This parameter is valid for T_{amb} = 25°C only.
- Unused pins at V_{CC} or GND.
- For valid test results, data must not be loaded into the flip-flops (or latches) after applying power.
- I_{CCZ} is measured with outputs pulled to V_{CC} or GND.
- This is the bus hold overdrive current required to force the input to the opposite logic state.

3.3V 16-bit edge-triggered D-type flip-flop (3-State)

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AC CHARACTERISTICS

GND = 0V; $t_R = t_F = 2.5\text{ns}$; $C_L = 50\text{pF}$; $R_L = 500\Omega$; $T_{\text{amb}} = -40^\circ\text{C}$ to $+85^\circ\text{C}$.

| SYMBOL | PARAMETER | WAVEFORM | LIMITS | | | | UNIT |
|--------------------------------------|--|----------|--------------------------|------------------|-----------------|------------|------|
| | | | $V_{CC} = 3.3V \pm 0.3V$ | | $V_{CC} = 2.7V$ | | |
| | | | MIN | TYP ¹ | MAX | MAX | |
| f_{max} | Maximum clock frequency | 1 | 150 | | | | MHz |
| t_{PLH} t_{PHL} | Propagation delay nCP to nQx | 1 | 1.5 | 2.9 | 5.0 | 5.6 | ns |
| t_{PZH} t_{PZL} | Output enable time to High and Low level | 3 4 | 1.5 | 3.2 | 4.8 | 6.0 5.2 | ns |
| t_{PHZ} t_{PLZ} | Output disable time from High and Low Level | 3 4 | 1.5 | 3.9 | 5.4 | 6.0 5.0 | ns |

NOTE:

1. All typical values are at $V_{CC} = 3.3V$ and $T_{\text{amb}} = 25^\circ\text{C}$.

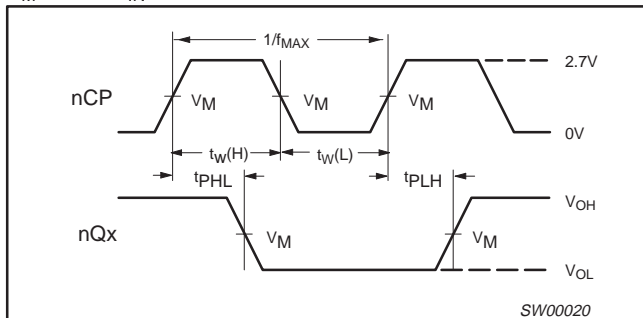
AC SETUP REQUIREMENTS

GND = 0V; $t_R = t_F = 2.5\text{ns}$; $C_L = 50\text{pF}$; $R_L = 500\Omega$; $T_{\text{amb}} = -40^\circ\text{C}$ to $+85^\circ\text{C}$.

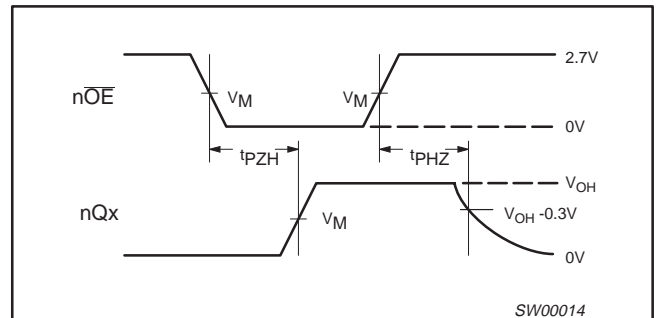
| SYMBOL | PARAMETER | WAVEFORM | LIMITS | | | UNIT |
|--|--------------------------------|----------|--------------------------|-----|-----------------|------|
| | | | $V_{CC} = 3.3V \pm 0.3V$ | | $V_{CC} = 2.7V$ | |
| | | | MIN | TYP | MIN | |
| $t_{\text{S(H)}}$ $t_{\text{S(L)}}$ | Setup time nDx to nCP | 2 | 2.5 | 0.7 | 2.5 | ns |
| $t_{\text{H(H)}}$ $t_{\text{H(L)}}$ | Hold time nDx to nCP | 2 | 0.5 | 0 | 0 | ns |
| $t_{\text{W(H)}}$ $t_{\text{W(L)}}$ | nCP pulse width High or Low | 1 | 1.5 | 0.6 | 1.5 | ns |

AC WAVEFORMS

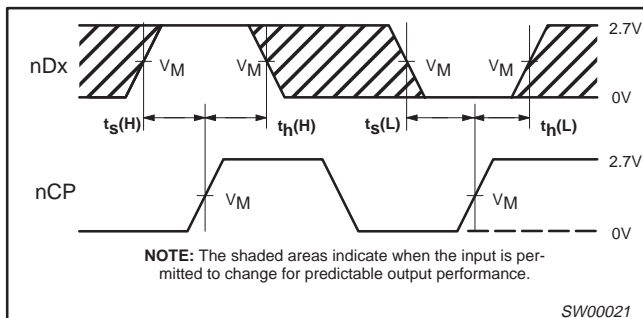
$V_M = 1.5V$, $V_{\text{IN}} = \text{GND}$ to $3.0V$



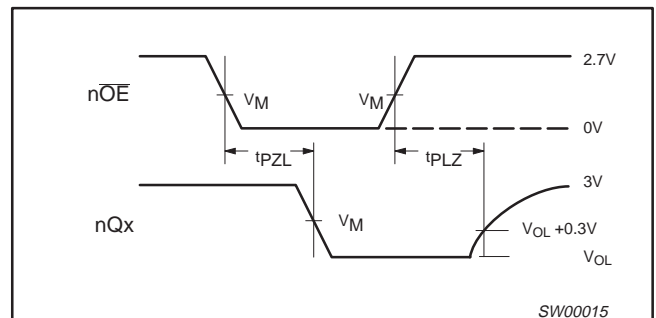
Waveform 1. Propagation Delay, Clock Input to Output, Clock Pulse Width, and Maximum Clock Frequency



Waveform 3. 3-State Output Enable Time to High Level and Output Disable Time from High Level



Waveform 2. Data Setup and Hold Times



Waveform 4. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

3.3V 16-bit edge-triggered D-type flip-flop (3-State)

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TEST CIRCUIT AND WAVEFORMS

Test Circuit for 3-State Outputs

SWITCH POSITION

| TEST | SWITCH |
|-------------------|--------|
| t_{PHZ}/t_{PZH} | GND |
| t_{PLZ}/t_{PZL} | 6V |
| t_{PLH}/t_{PHL} | open |

DEFINITIONS

R_L = Load resistor; see AC CHARACTERISTICS for value.

C_L = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

**$V_M = 1.5V$
Input Pulse Definition**

| FAMILY | INPUT PULSE REQUIREMENTS | | | | |
|---------|--------------------------|---------------------|-------|---------------------|---------------------|
| | Amplitude | Rep. Rate | t_W | t_R | t_F |
| 74LVT16 | 2.7V | $\leq 10\text{MHz}$ | 500ns | $\leq 2.5\text{ns}$ | $\leq 2.5\text{ns}$ |

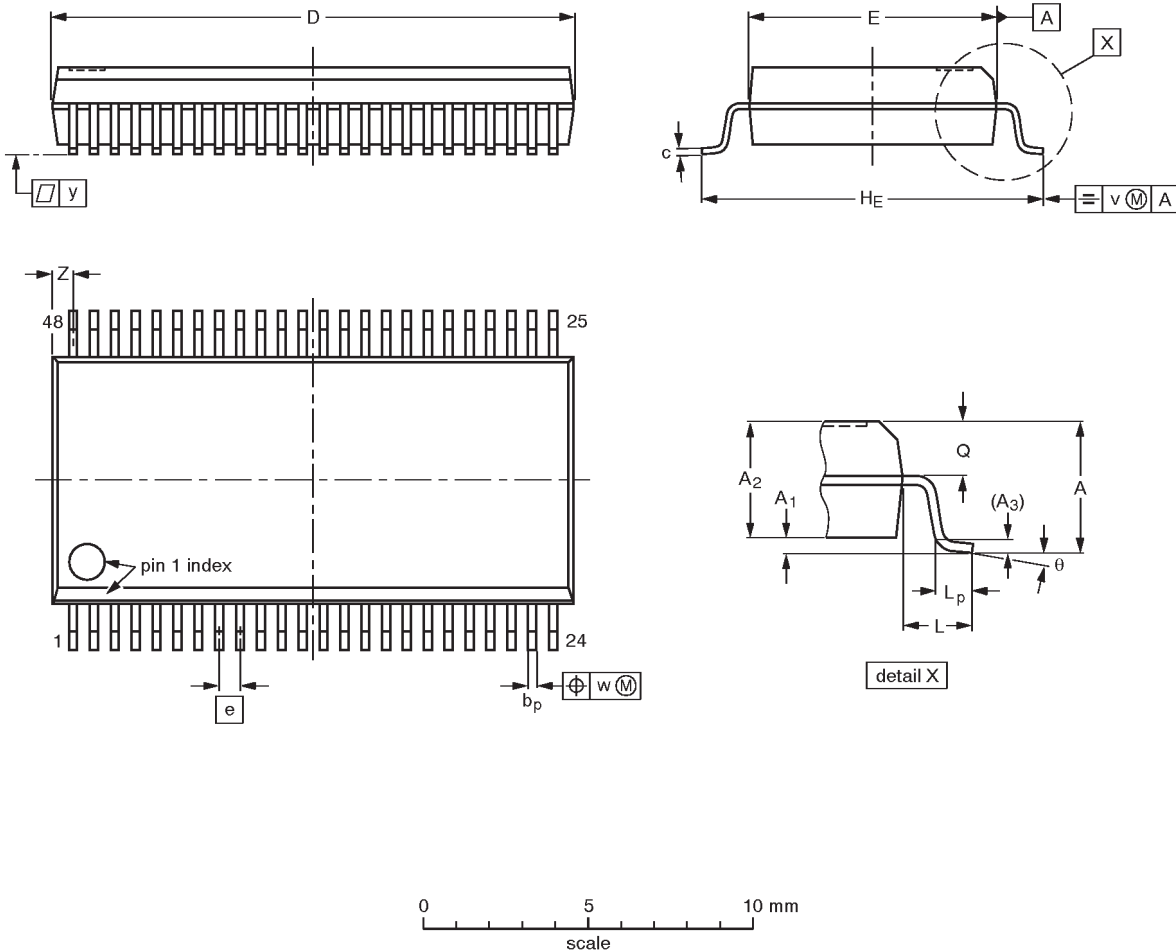
SW00003

3.3V LVT 16-bit edge-triggered D-type flip-flop (3-State)

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SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽¹⁾ | e | H _E | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|------|--------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|-------|----------------|-----|----------------|------------|------|------|-----|------------------|----------|
| mm | 2.8 | 0.4 0.2 | 2.35 2.20 | 0.25 | 0.3 0.2 | 0.22 0.13 | 16.00 15.75 | 7.6 7.4 | 0.635 | 10.4 10.1 | 1.4 | 1.0 0.6 | 1.2 1.0 | 0.25 | 0.18 | 0.1 | 0.85 0.40 | 8° 0° |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

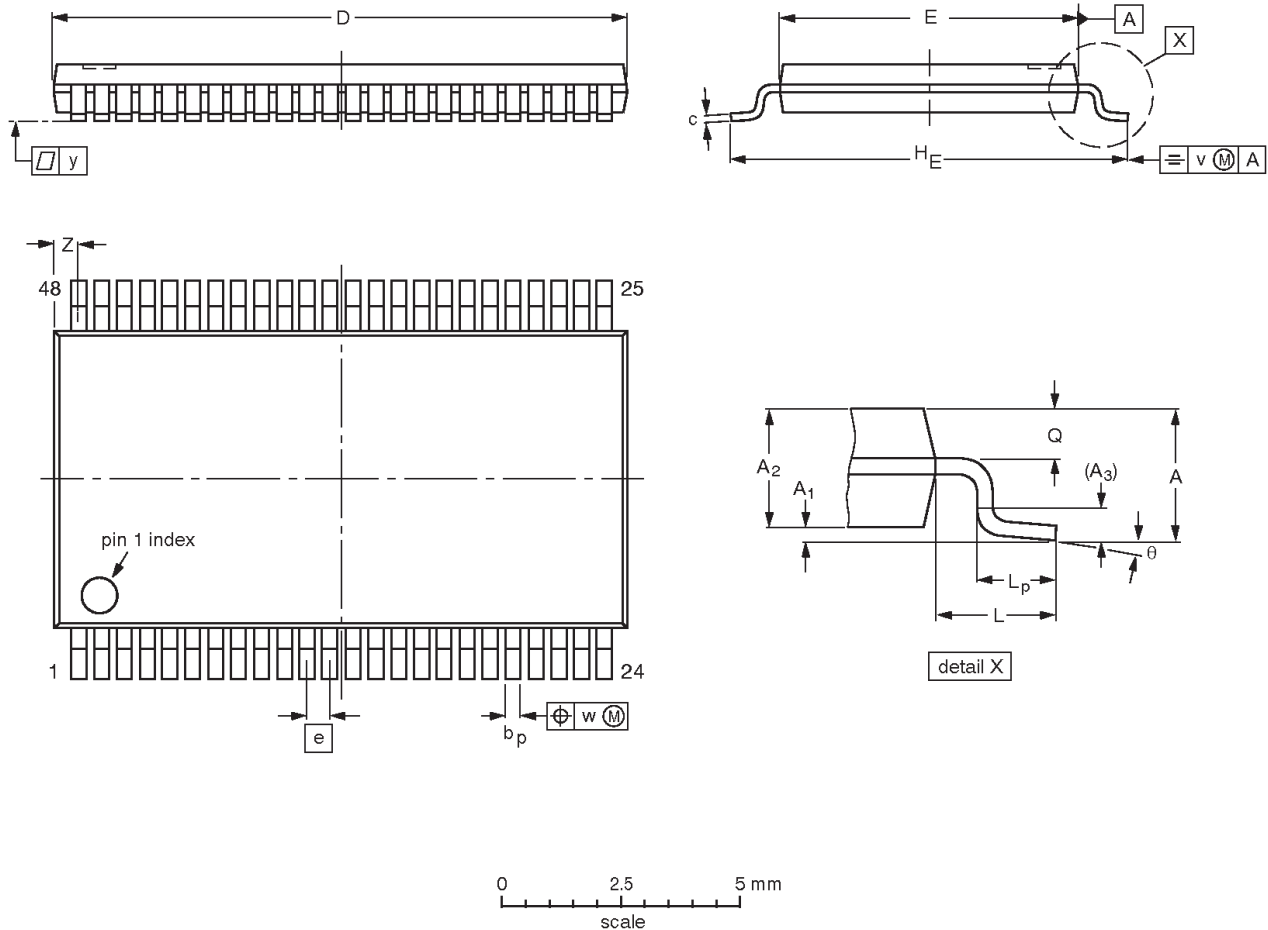
| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|------------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT370-1 | | MO-118AA | | | | -93-11-02- 95-02-04 |

3.3V LVT 16-bit edge-triggered D-type flip-flop (3-State)

74LVT16374A

TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1mm

SOT362-1



DIMENSIONS (mm are the original dimensions).

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽²⁾ | e | H _E | L | L _p | Q | v | w | y | Z | θ |
|------|--------|----------------|----------------|----------------|----------------|------------|------------------|------------------|-----|----------------|---|----------------|--------------|------|------|-----|------------|----------|
| mm | 1.2 | 0.15 0.05 | 1.05 0.85 | 0.25 | 0.28 0.17 | 0.2 0.1 | 12.6 12.4 | 6.2 6.0 | 0.5 | 8.3 7.9 | 1 | 0.8 0.4 | 0.50 0.35 | 0.25 | 0.08 | 0.1 | 0.8 0.4 | 8° 0° |

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT362-1 | | MO-153ED | | | | 93-02-03 95-02-10 |

3.3V LVT 16-bit edge-triggered D-type flip-flop (3-State)

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Data sheet status

| Data sheet status | Product status | Definition [1] |
|---------------------------|----------------|--|
| Objective specification | Development | This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice. |
| Preliminary specification | Qualification | This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product. |
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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